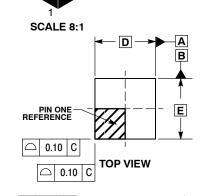
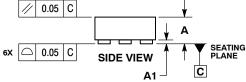
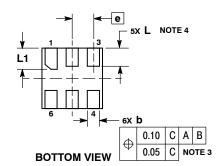
ULLGA6, 1.0x1.0, 0.35P CASE 613AD-01 **ISSUE A** 

**DATE 05 FEB 2008** 





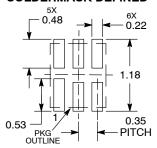


## NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL THE AMAIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL TROM THE EDGE OF THE PLATED TERMINAL FROM THE EDGE OF THE PLATED TERMINAL FROM THE EDGE OF THE PLATED TERMINAL FROM THE EDGE OF THE
- PACKAGE IS ALLOWED.

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.40	
A1	0.00 0.05		
b	0.12	0.22	
D	1.00 BSC		
E	1.00 BSC		
е	0.35 BSC		
L	0.25	0.35	
L1	0.30	0.40	

## **MOUNTING FOOTPRINT SOLDERMASK DEFINED\***



**DIMENSIONS: MILLIMETERS** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	ULLGA6, 1.0X1.0, 0.35P	•	PAGE 1 OF 1

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